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(12) **United States Design Patent**
Park et al.

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(54) **WIRELESS HEADSET**

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(73) Assignee: **LG ELECTRONICS INC.**, Seoul (KR)

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(51) **LOC (10) Cl.** **14-01**

(52) **U.S. Cl.**
USPC **D14/205**

(58) **Field of Classification Search**
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379/430, 431; 381/380, 381, 74, 370;
455/90.3, 575.1

CPC H04R 25/00; H04R 1/10; H04R 1/1066;
H04R 1/1016; H04R 5/033; H04R
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H04R 1/1083

See application file for complete search history.

(56) **References Cited**

U.S. PATENT DOCUMENTS

2,481,946 A * 9/1949 Pendleton G02C 3/003
2/450

2,891,116 A * 6/1959 Nichols H04R 25/602
381/323

D318,669 S * 7/1991 Nakayama D14/205

D331,057 S * 11/1992 Isonaga D14/205

D337,587 S * 7/1993 Nakayama D14/205
D350,354 S * 9/1994 Nakamura D14/205
D351,597 S * 10/1994 Nakamura D14/205
D394,436 S * 5/1998 Hall D14/206
5,829,062 A * 11/1998 Magidson A61F 11/12
128/867

6,010,216 A * 1/2000 Jesiek H04B 1/385
351/158

6,105,714 A * 8/2000 Lindgren A61F 11/08
181/126

6,233,345 B1 * 5/2001 Urwyler H04R 1/1033
351/123

D449,290 S * 10/2001 Taylor D14/206

(Continued)

OTHER PUBLICATIONS

LG Electronics Inc. releases new product—premium Bluetooth Headset ‘Tone Plus’, Dec. 28, 2015, “<http://www.iusm.co.kr/news/articleView.html?idxno=635049>”.

Primary Examiner — Paula Allen Greene

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(57) **CLAIM**

The ornamental design for wireless headset, as shown and described.

DESCRIPTION

FIG. 1 is a perspective view of a wireless headset showing our new design;

FIG. 2 is a front view thereof;

FIG. 3 is a rear view thereof;

FIG. 4 is a left side view thereof;

FIG. 5 is a right side view thereof;

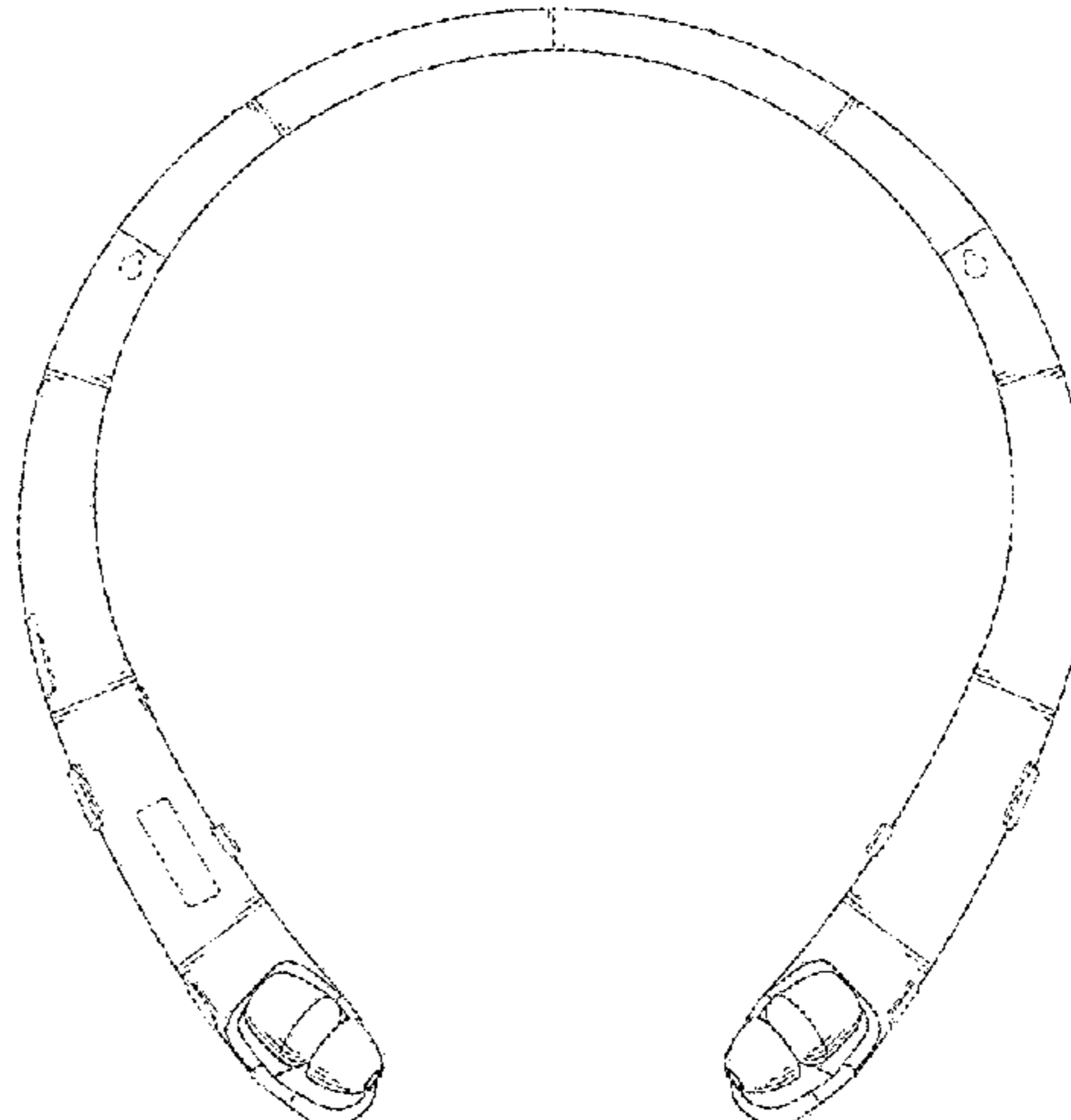
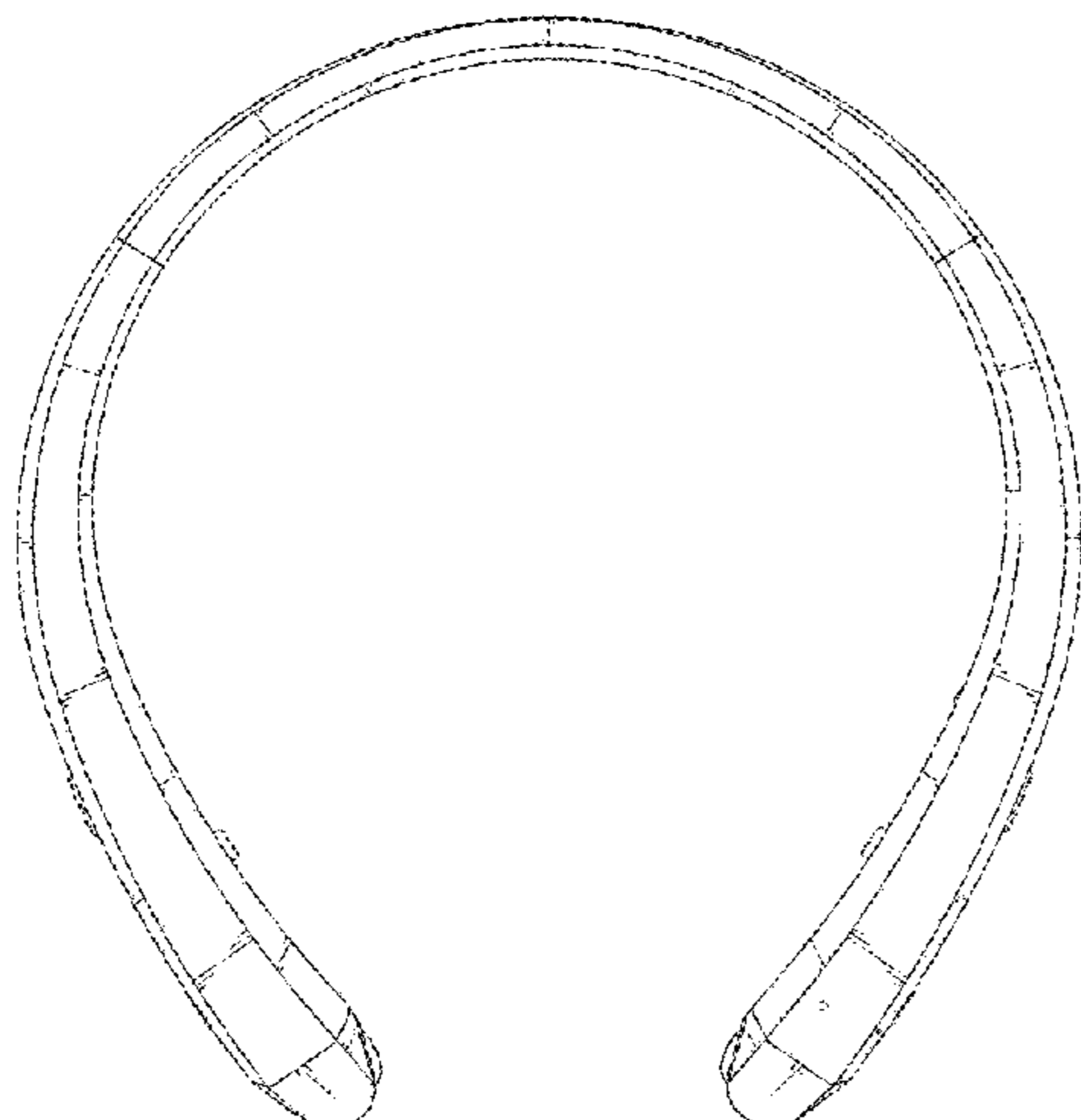
FIG. 6 is a top plan view thereof;

FIG. 7 is a bottom plan view thereof; and,

FIG. 8 is a reference view thereof showing an example of the usage of the subject design.

The broken lines depict portions of the wireless headset that form no part of the claimed design.

1 Claim, 7 Drawing Sheets



(56)

References Cited

U.S. PATENT DOCUMENTS

D458,245 S *	6/2002	Masuda	D14/192	8,873,250 B2 *	10/2014	Kroupa	B65H 75/4434
6,603,863 B1 *	8/2003	Nagayoshi	H04R 1/1066				242/400
			381/370	D716,759 S *	11/2014	Ha	D14/205
D502,463 S *	3/2005	Bhakta	D14/205	D717,765 S *	11/2014	Rausch	D14/205
D533,539 S *	12/2006	Mah	D14/205	D718,272 S *	11/2014	Clayton	D14/205
D550,202 S *	9/2007	Meier	D14/206	D721,673 S *	1/2015	Park	D14/205
D560,206 S *	1/2008	Hermansen	D14/206	D723,510 S *	3/2015	Ishikura	D14/205
D575,268 S *	8/2008	Christopher	D14/205	D730,867 S *	6/2015	Park	D14/205
D579,442 S *	10/2008	Kim	D14/205	D731,999 S *	6/2015	Cepress	D14/205
D583,800 S *	12/2008	Jaakkola	D14/205	9,055,795 B2 *	6/2015	Larkin	A45C 11/00
D587,678 S *	3/2009	Yuyama	D14/205	D736,740 S *	8/2015	Hwang	D14/205
D587,680 S *	3/2009	Komiyama	D14/205	D740,785 S *	10/2015	Chen	D14/205
D593,067 S *	5/2009	Millora	D14/205	D743,933 S *	11/2015	Park	D14/205
D593,538 S *	6/2009	Chon	D14/205	D752,026 S *	3/2016	Yang	D14/223
D594,442 S *	6/2009	Chon	D14/205	D756,958 S *	5/2016	Lee	D14/205
D596,617 S *	7/2009	Devlas	D14/205	D756,959 S *	5/2016	Lee	D14/205
D604,269 S *	11/2009	Choe	D14/205	D762,617 S *	8/2016	Park	D14/205
D605,168 S *	12/2009	Jaakkola	D14/205	D763,227 S *	8/2016	Lee	D14/205
D617,308 S *	6/2010	Nousiainen	D14/205	D763,822 S *	8/2016	Lee	D14/205
7,920,902 B2 *	4/2011	Carroll	H04M 1/6066	D766,869 S *	9/2016	Lee	D14/205
			381/74	D768,600 S *	10/2016	Chen	D14/205
8,009,853 B2 *	8/2011	Ito	H04R 1/1066	D771,011 S *	11/2016	Ott	D14/205
			381/370	D771,013 S *	11/2016	Yang	D14/205
D645,444 S *	9/2011	Quek	D14/205	D771,588 S *	11/2016	Choe	D14/205
D653,234 S *	1/2012	Lee	D14/205	D772,196 S *	11/2016	Choi	D14/205
8,094,858 B2 *	1/2012	Thiel	G02C 3/003	D772,843 S *	11/2016	Lee	D14/205
			381/327	D772,845 S *	11/2016	Lim	D14/205
D663,714 S *	7/2012	Kang	D14/205	D774,017 S *	12/2016	Ahn	D14/205
D669,881 S *	10/2012	Clements	D14/205	D776,636 S *	1/2017	Lim	D14/205
8,290,193 B2 *	10/2012	Pang	H04R 1/1033	D777,136 S *	1/2017	Erbeus	D14/205
			381/370	D781,815 S *	3/2017	Choi	D14/205
8,363,875 B2 *	1/2013	Ito	H04R 1/1066	D781,816 S *	3/2017	Choe	D14/205
			381/379	D781,817 S *	3/2017	Lee	D14/205
D678,857 S *	3/2013	Feng	D14/205	D782,998 S *	4/2017	Shin	D14/205
D678,858 S *	3/2013	Feng	D14/205	2006/0088171 A1 *	4/2006	Yeh	H04R 5/0335
8,411,893 B2 *	4/2013	Ito	H04R 1/105				381/74
			181/135	2007/0003095 A1 *	1/2007	Slamka	H04R 1/086
8,433,082 B2 *	4/2013	Abolfathi	H04R 1/46				381/381
			381/151	2009/0274335 A1 *	11/2009	Cheung	H04R 5/0335
D686,189 S *	7/2013	Lu	D14/205				381/374
D695,264 S *	12/2013	Chee	D14/205	2010/0283962 A1 *	11/2010	Williams	G02C 3/003
D703,634 S *	4/2014	Han	H04R 1/1016				351/157
			D14/205	2011/0170702 A1 *	7/2011	Bays	H04R 5/0335
D706,745 S *	6/2014	Nakagawa	H04R 1/1066				381/74
			D14/205	2012/0314351 A1 *	12/2012	Kroupa	B65H 75/4434
D707,199 S *	6/2014	Cepress	H04R 1/10				361/679.01
			D14/205	2013/0329903 A1 *	12/2013	Ting	H04R 1/105
8,761,430 B2 *	6/2014	Zimmerman	H04R 1/1033				381/74
			381/374	2014/0185837 A1 *	7/2014	Kunimoto	H04R 1/1075
D712,371 S *	9/2014	Henning	D14/205				381/151
				2017/0195767 A1 *	7/2017	Kim	H04R 1/1016
				2017/0195768 A1 *	7/2017	Kim	H04R 1/1016

* cited by examiner

FIG. 1

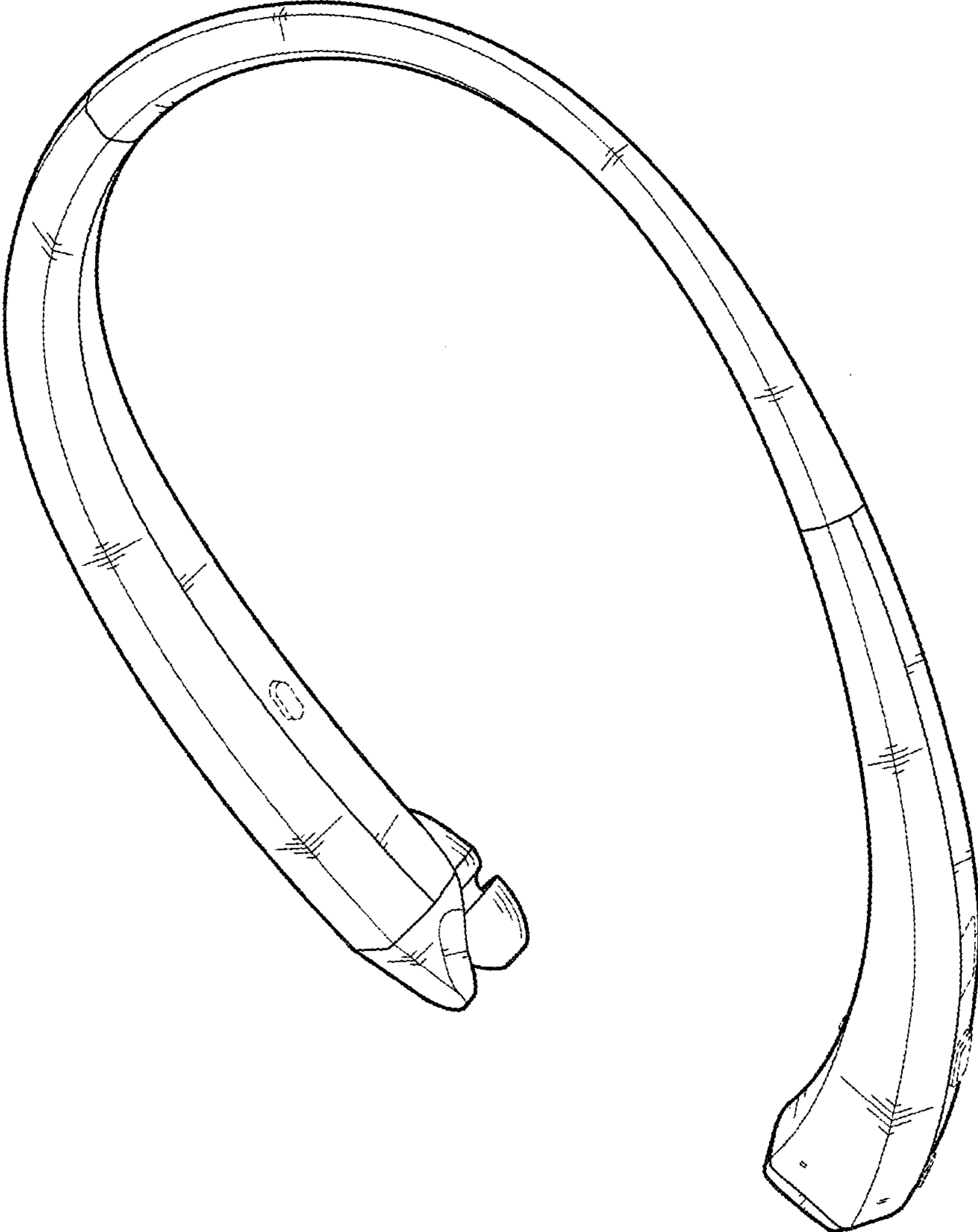


FIG. 2

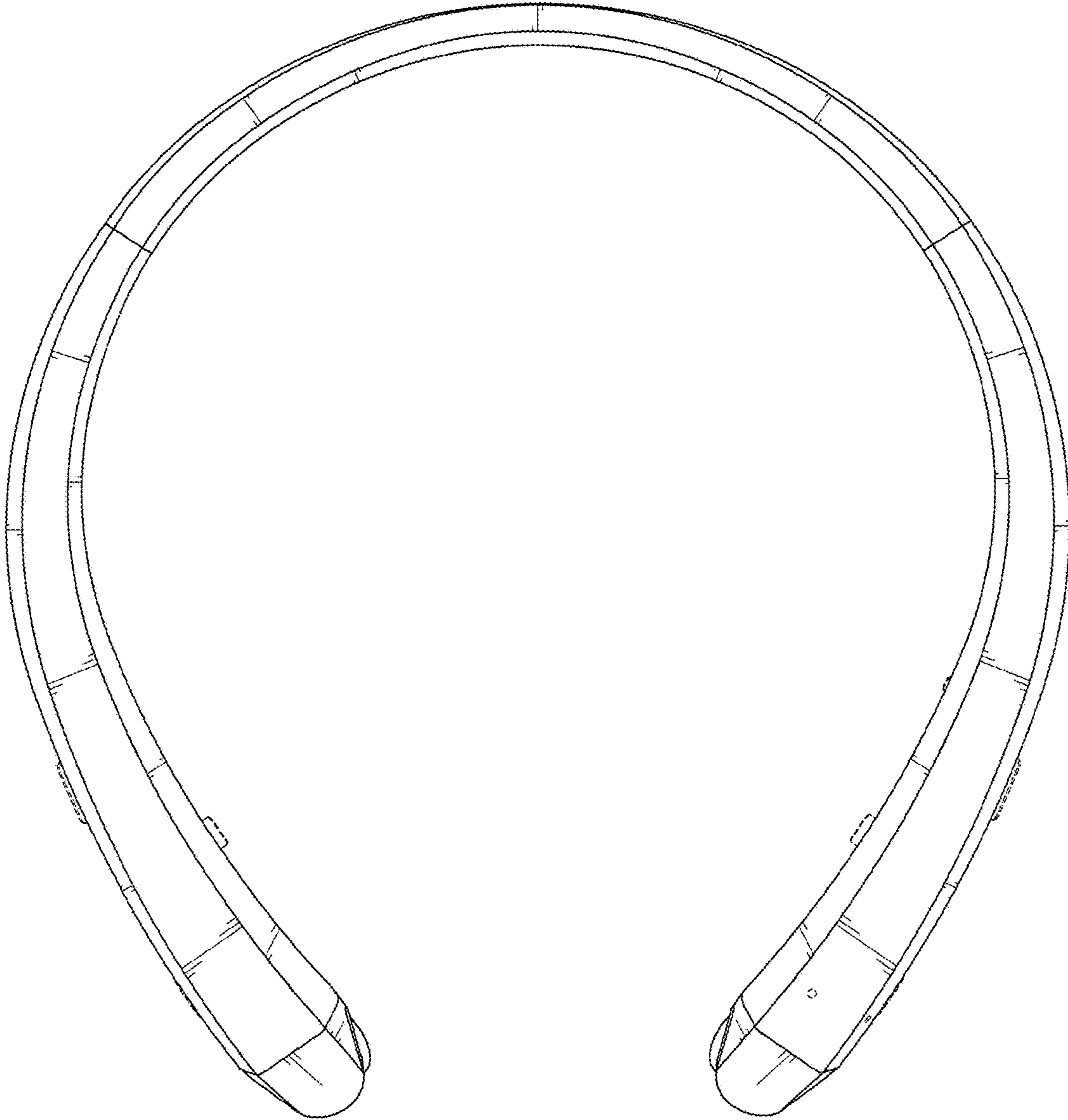


FIG. 3

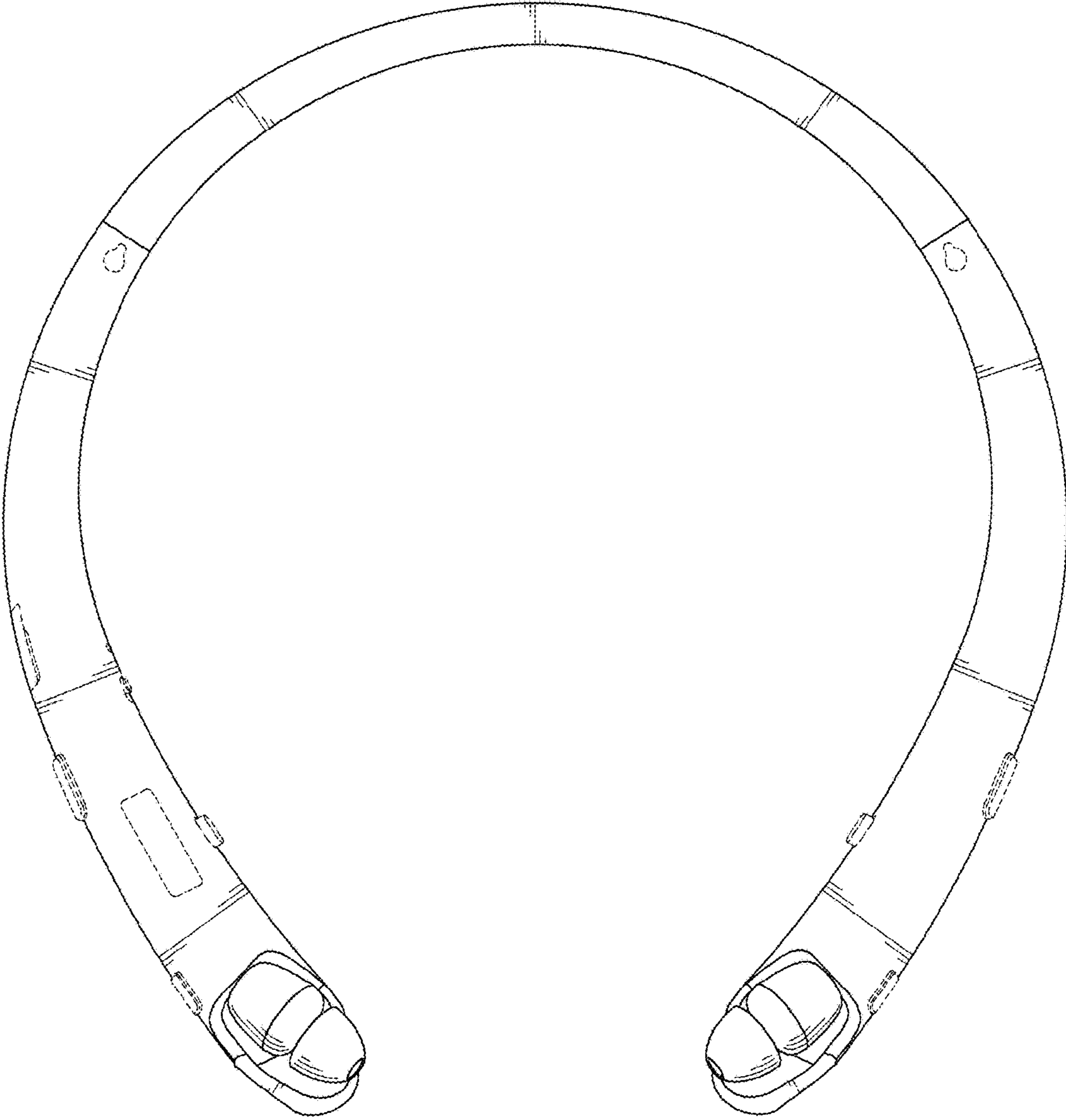


FIG. 4

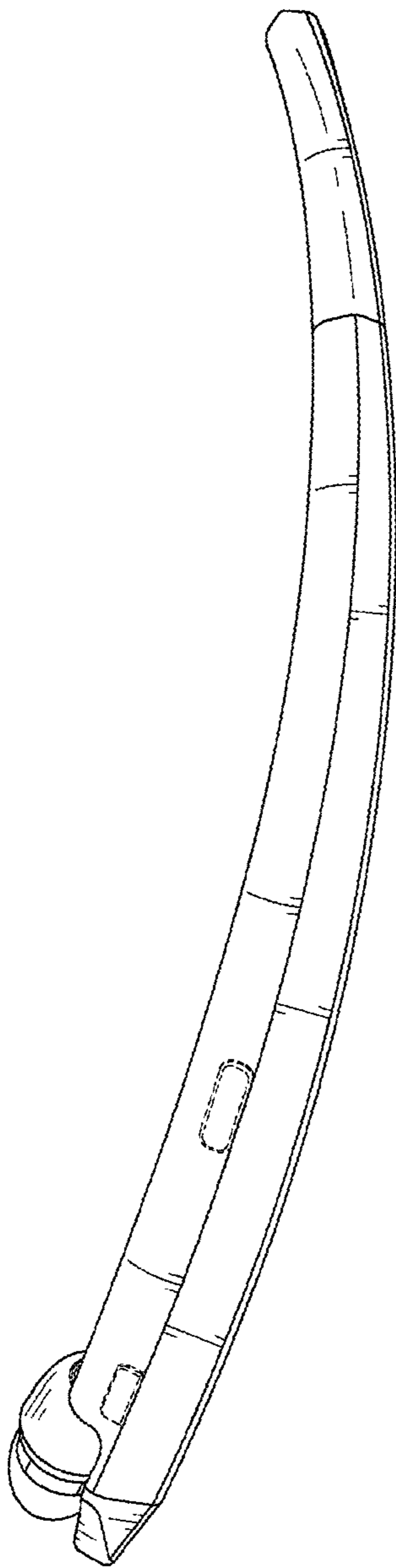


FIG. 5

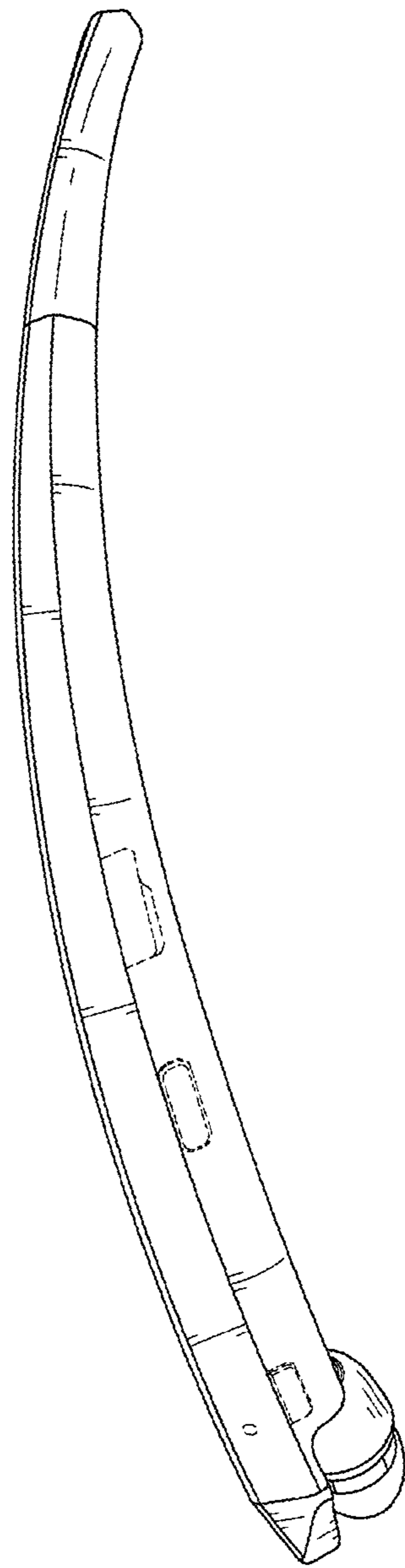


FIG. 6

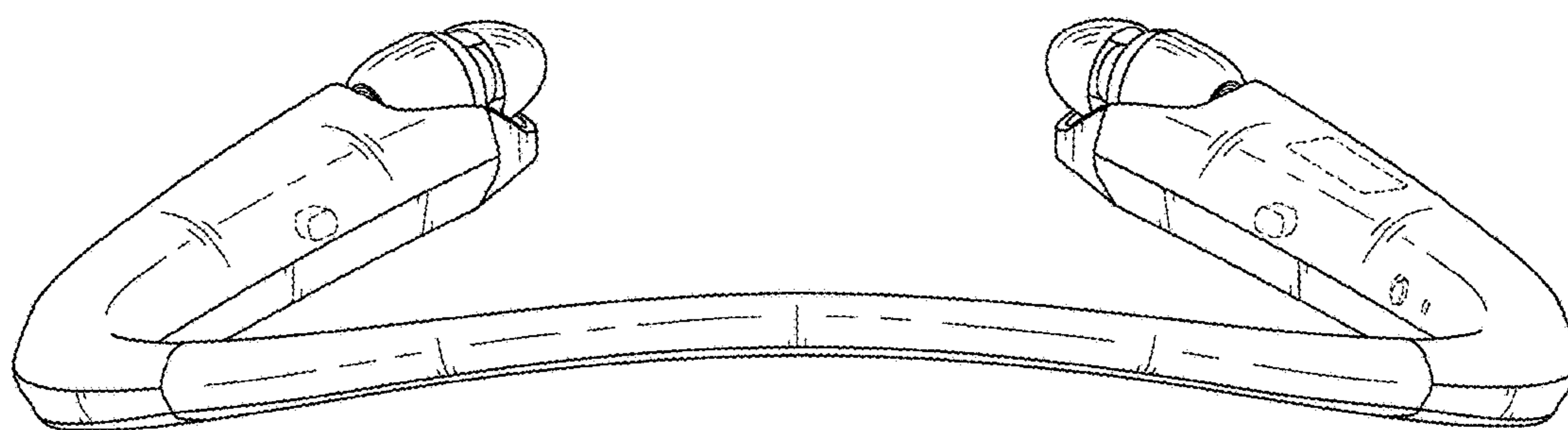


FIG. 7

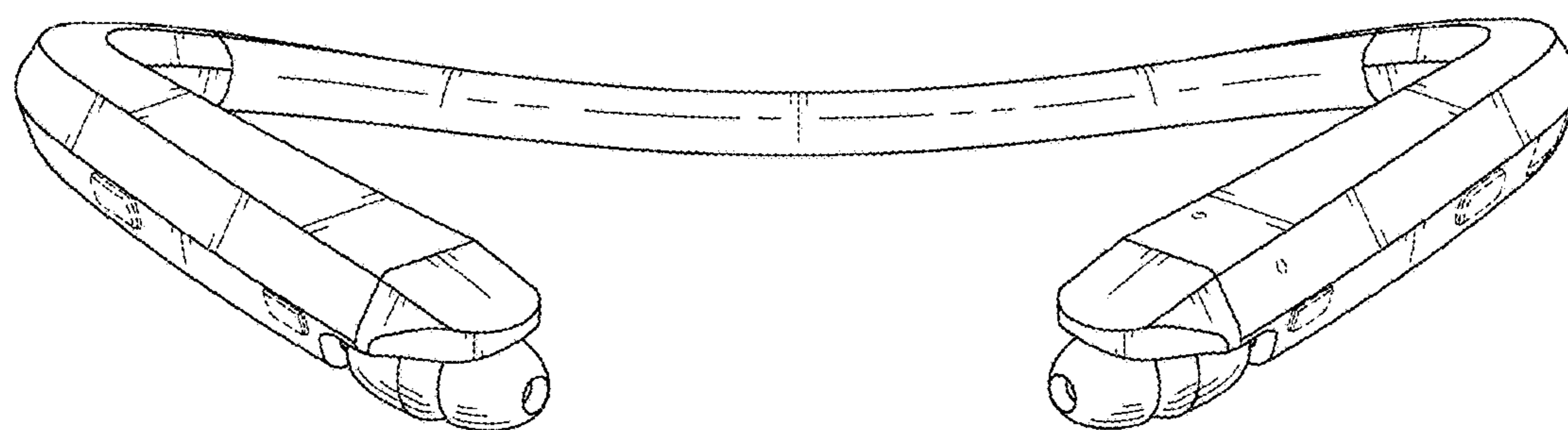


FIG. 8

